

# Wei Qiyu

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## EDUCATION

### Shanghai University

Shanghai, China

*Master of Microelectronics and solid-state electronics*

*September 2021 - Expected March 2024*

- Research Direction: Semiconductor with Artificial Intelligence Supervisor: Prof. Zeng Zeng
- WAM: 87.6/100 (Ranking: Top 5%)
- Award: First-class Scholarship

### Nanjing University of Posts and Telecommunications

Nanjing, China

*Bachelor of Communication engineering (Bell Honor school Elite Class)*

*September 2017 - June 2021*

- WAM: 87.3/100 (Ranking: Top 5%)
- Award: Miyoshi students, Outstanding student leaders, Second-class Scholarship

## PAPERS

- **Qiyu, W.**, Weihua Z., Yuxin, L., Zeng, Z., Yang, X.. (2023, October). Controlling Facial Attribute Synthesis by Disentangling Attribute Feature Axes in Latent Space. In 2022 IEEE International Conference on Image Processing (ICIP). IEEE. (**CCF-C**)
- **Qiyu, W.**, Wei Z., Zeng, Z.(2023, June). Wafer Map Defect Patterns Semi-Supervised Classification Using Latent Vector Representation. In 2023 IEEE International Conference on Cybernetics and Intelligent Systems(CIS).IEEE.
- **Qiyu, W.**, Yang, X., Sang, T., Wang, H., Xiaofeng, Z., Zhongyao, C., ... Zeng, Z. (2022, October). Latent Vector Prototypes Guided Conditional Face Synthesis. In 2022 IEEE International Conference on Image Processing (ICIP) (pp. 3898-3902). IEEE. (**CCF-C**)
- **Qiyu, W.**, Ma, R., Wang, Y., Chen, M., Sun, Y., Liu, M., Lin, X. (2020, July). Glad: A method of microgrid anomaly detection based on esd in smart power grid. In 2020 IEEE International Conference on Power, Intelligent Computing and Systems (ICPICS) (pp. 103-107). IEEE.
- Wei Z., **Qiyu, W.**, Zeng Z.(2023, September). A Deeply Supervised Semantic Segmentation Method Based on GAN. In 2023 IEEE International Conference on Intelligent Transportation System (ITSC).
- Peng liu, Haowei Wang, **Qiyu, W.**(2023, October). Bayesian Optimization with Switching Cost: Regret Analysis and Lookahead Variants. In 2023 International Joint Conferences on Artificial Intelligence (IJCAI). (**CCF-A**)
- Tang, X., Liu, Y., Deng, T., Zeng, Z., Huang, H., **Qiyu, W.**, ... Yang, L. (2023). A job scheduling algorithm based on parallel workload prediction on computational grid. Journal of Parallel and Distributed Computing, 171, 88-97.(**CCF-B**)
- (Major revision) Sang, T., **Wei, Q.**, Xiaofeng, Z.,Zeng, Z., Yang, X..Towards Efficient Point Cloud Classification via Dynamic Graph Neural Networks. IEEE Transactions on Intelligent Transportation Systems(**CCF-B**)

## PATENTS

**Granted** | *CN 202010882457.5* | First author

August 2020

- Vehicle-mounted video distributed scheduling and vehicle-connected communication system

**submitted** | *CN 202311088688.9* | First author

April 2023

- A invention relates to a wafer defect detection method with high precision and adapted to different density variations

**submitted** | *CN 202211069040.2* | Second author

August 2022

- A wafer defect detection method with high accuracy and adapted to different density variations

## RESEARCH EXPERIENCE

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### Agency for Science, Technology and Research(A\*STAR)

Research assistant, supervised by Dr. Yang Xulei

Singapore, Singapore  
June 2023 - Expected December 2023

- Supported by the SIPGA Scholarship
- My research includes:
  - Semi-supervised algorithm in semiconductor defect detection
  - 3D machine learning in semiconductor data

## PROJECTS

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<b>Chip packaging fault detection with CV</b>   <i>Shanghai Micro Electronics Equipment</i>	April 2022 – April 2023
<b>Time series data analysis and fault tracing</b>   <i>Shanghai Micro Electronics Equipment</i>	April 2022 – August 2022
<b>AI in EDA</b>   <i>Shanghai Industrial <math>\mu</math> Technology Research Institute</i>	September 2021 – May 2022
<b>CD measure</b>   <i>Shanghai, Huahong fab5</i>	March 2023 – Now

## SELECTED AWARDS AND HONORS

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<b>The Ace Land Cup 2022</b>   <i>Winning Prize(Ranked 5/465)</i>	May 2022
<b>National Post-Graduate Mathematical Contest in Modeling</b>   <i>The second prize</i>	October 2021
<b>Mathematical Contest In Modeling (MCM/ICM)</b>   <i>Outstanding Winner (Top 0.12 %)</i>	February 2020
<b>National College Students Mathematical Contest in Modeling</b>   <i>The second prize</i>	October 2019
<b>NJUPT Students Mathematical Contest in Modeling</b>   <i>The first prize</i>	May 2019

## EXPERIENCE

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<b>Visiting student</b> <i>University of California, Berkeley</i>	January 2019 – February 2019 <i>California, USA</i>
<b>Minister of CS Department of Science Association</b> <i>Nanjing University of Posts and Telecommunications</i>	September 2018 – October 2019 <i>Nanjing, China</i>

## TECHNICAL SKILLS

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**Programming languages:** Python, C  
**ML/AI:** Pytorch, Tensorflow, Paddle, Numpy, Pandas, Matplotlib